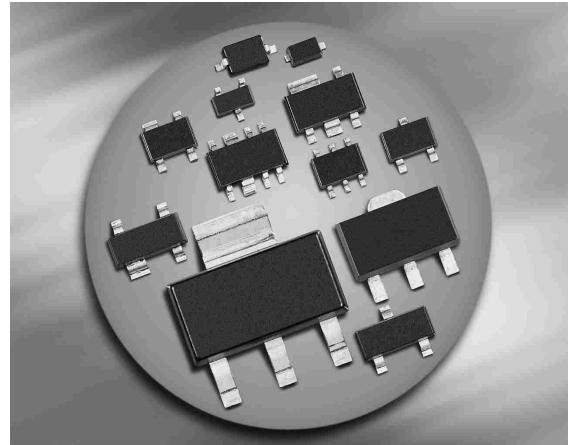
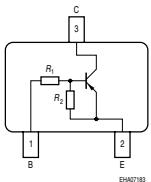
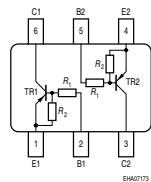


### PNP Silicon Digital Transistor

- Switching circuit, inverter, interface circuit, driver circuit
- Built in bias resistor ( $R_1 = 10 \text{ k}\Omega$ ,  $R_2 = 10 \text{ k}\Omega$ )
- BCR183S / U: Two internally isolated transistors with good matching in one multichip package



**BCR183/F/L3**  
**BCR183T/W**



Type	Marking	Pin Configuration							Package
BCR183	WMs	1=B	2=E	3=C	-	-	-	-	SOT23
BCR183F	WMs	1=B	2=E	3=C	-	-	-	-	TSFP-3
BCR183L3	WM	1=B	2=E	3=C	-	-	-	-	TSLP-3-4
BCR183S	WMs	1=E1	2=B1	3=C2	4=E2	5=B2	6=C1	-	SOT363
BCR183T	WMs	1=B	2=E	3=C	-	-	-	-	SC75
BCR183U	WMs	1=E1	2=B1	3=C2	4=E2	5=B2	6=C1	-	SC74
BCR183W	WMs	1=B	2=E	3=C	-	-	-	-	SOT323

### Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CEO}$	50	V
Collector-base voltage	$V_{CBO}$	50	
Emitter-base voltage	$V_{EBO}$	10	
Input on voltage	$V_{i(on)}$	20	
Collector current	$I_C$	100	mA
Total power dissipation- BCR183, $T_S \leq 102^\circ\text{C}$ BCR183F, $T_S \leq 128^\circ\text{C}$ BCR183L3, $T_S \leq 135^\circ\text{C}$ BCR183S, $T_S \leq 115^\circ\text{C}$ BCR183T, $T_S \leq 109^\circ\text{C}$ BCR183U, $T_S \leq 118^\circ\text{C}$ BCR183W, $T_S \leq 124^\circ\text{C}$	$P_{tot}$	200 250 250 250 250 250 250	mW
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-65 ... 150	

### Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup> BCR183 BCR183F BCR183L3 BCR183S BCR183T BCR183U BCR183W	$R_{thJS}$	$\leq 240$ $\leq 90$ $\leq 60$ $\leq 140$ $\leq 165$ $\leq 133$ $\leq 105$	K/W

<sup>1</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

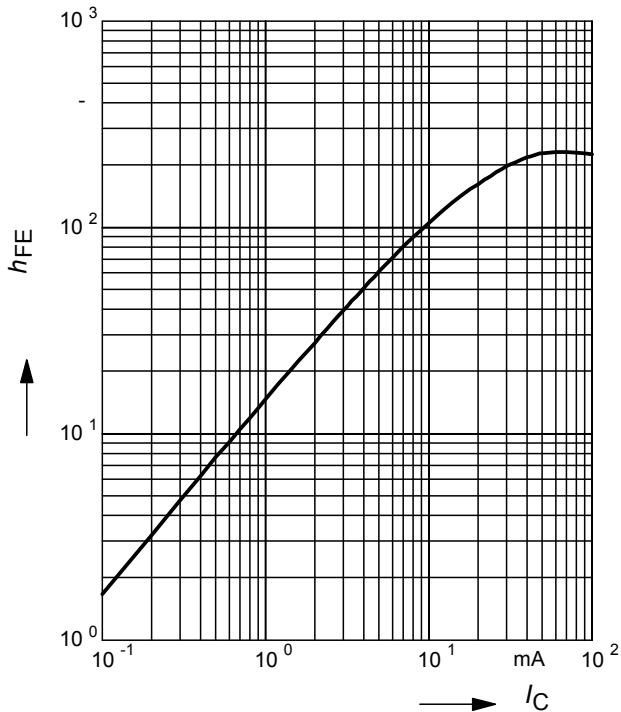
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Collector-emitter breakdown voltage $I_C = 100 \mu\text{A}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	50	-	-	V
Collector-base breakdown voltage $I_C = 10 \mu\text{A}, I_E = 0$	$V_{(\text{BR})\text{CBO}}$	50	-	-	
Collector-base cutoff current $V_{CB} = 40 \text{ V}, I_E = 0$	$I_{\text{CBO}}$	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 10 \text{ V}, I_C = 0$	$I_{\text{EBO}}$	-	-	0.75	mA
DC current gain <sup>1)</sup> $I_C = 5 \text{ mA}, V_{CE} = 5 \text{ V}$	$h_{\text{FE}}$	30	-	-	-
Collector-emitter saturation voltage <sup>1)</sup> $I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$	$V_{\text{CEsat}}$	-	-	0.3	V
Input off voltage $I_C = 100 \mu\text{A}, V_{CE} = 5 \text{ V}$	$V_{i(\text{off})}$	0.8	-	1.8	
Input on voltage $I_C = 2 \text{ mA}, V_{CE} = 0.3 \text{ V}$	$V_{i(\text{on})}$	1	-	2.5	
Input resistor	$R_1$	7	10	13	kΩ
Resistor ratio	$R_1/R_2$	0.9	1	1.1	-

**AC Characteristics**

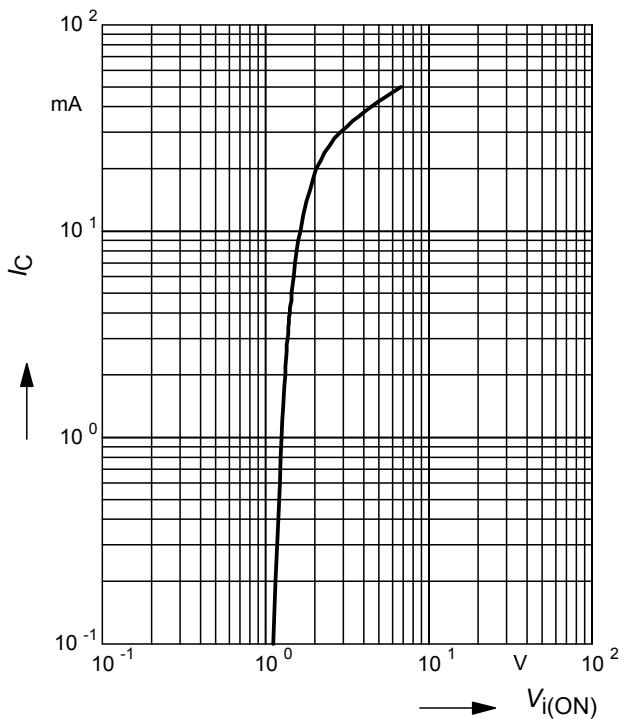
Transition frequency $I_C = 10 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$	$f_T$	-	200	-	MHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{cb}$	-	3	-	pF

<sup>1</sup>Pulse test:  $t < 300\mu\text{s}$ ;  $D < 2\%$

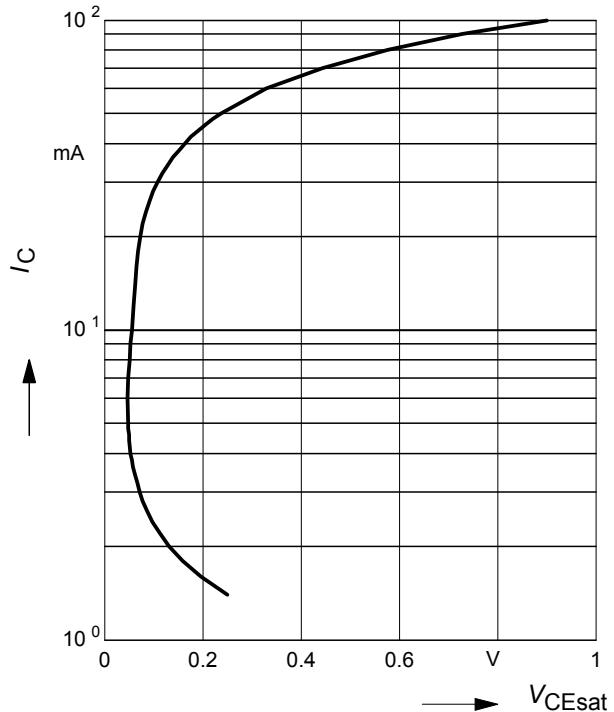
**DC current gain**  $h_{FE} = f(I_C)$   
 $V_{CE} = 5 \text{ V}$  (common emitter configuration)



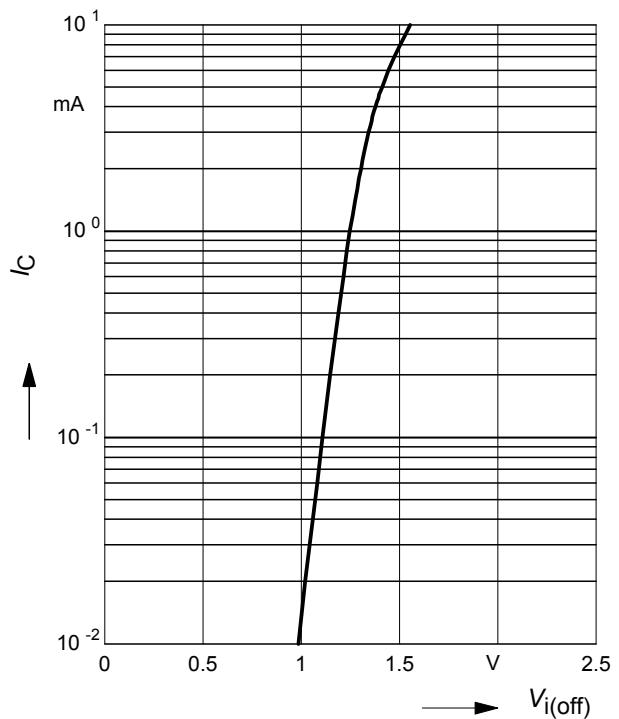
**Input on Voltage**  $V_{i(on)} = f(I_C)$   
 $V_{CE} = 0.3 \text{ V}$  (common emitter configuration)



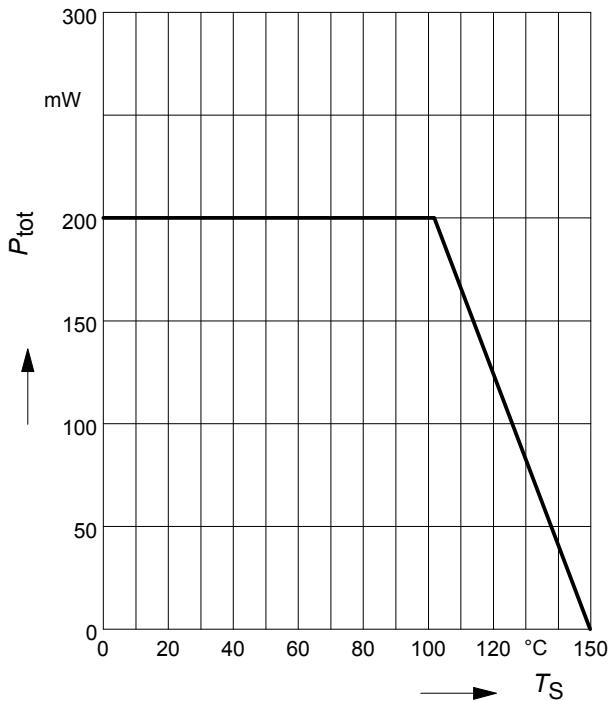
**Collector-emitter saturation voltage**  
 $V_{CEsat} = f(I_C)$ ,  $h_{FE} = 20$



**Input off voltage**  $V_{i(off)} = f(I_C)$   
 $V_{CE} = 5 \text{ V}$  (common emitter configuration)

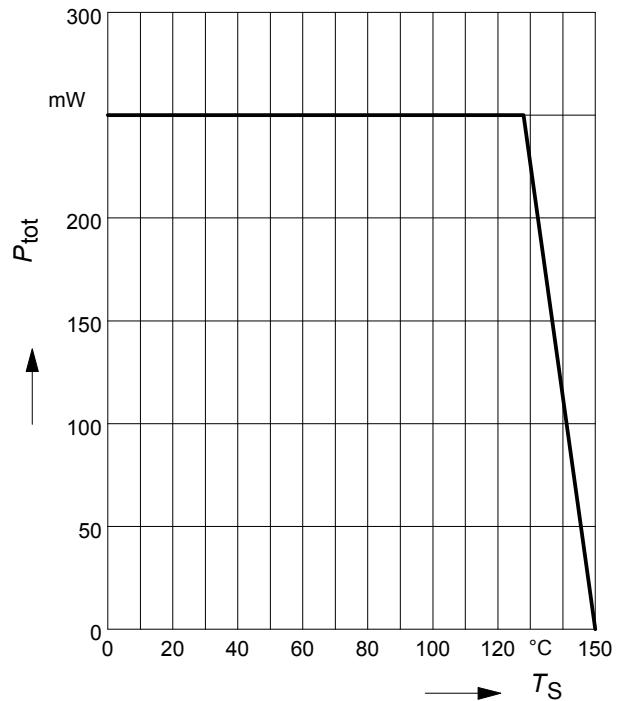


**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
BCR183



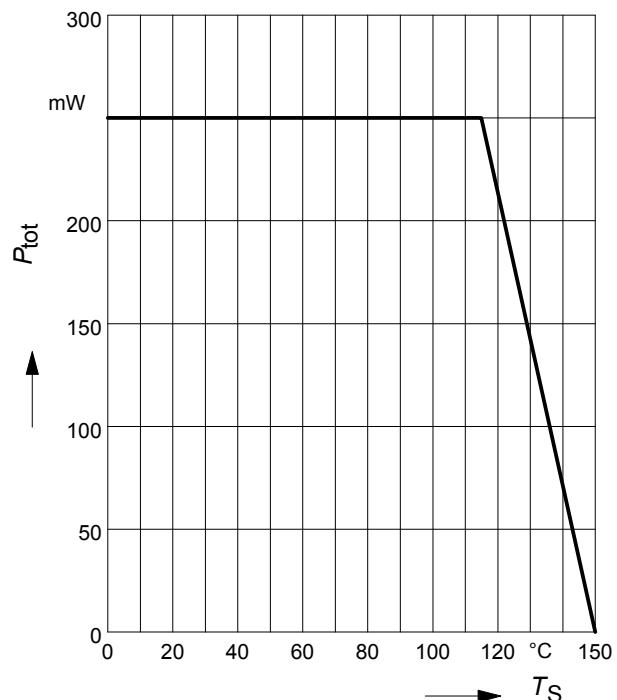
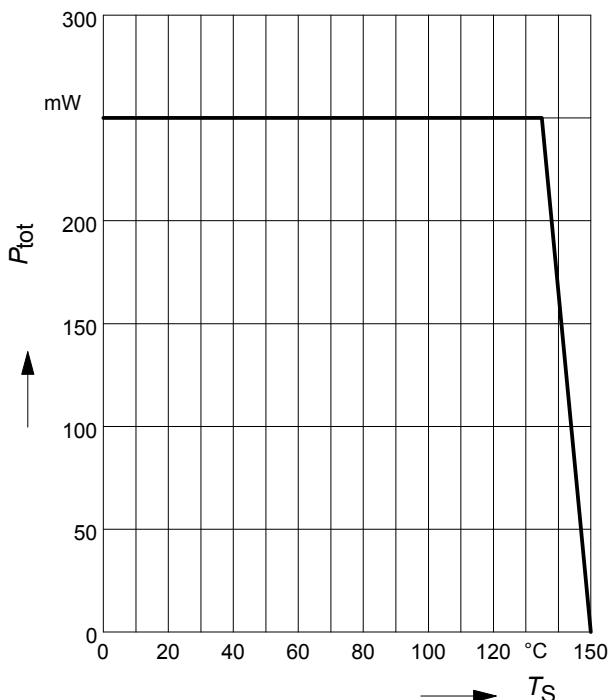
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
BCR183F

**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
BCR183F



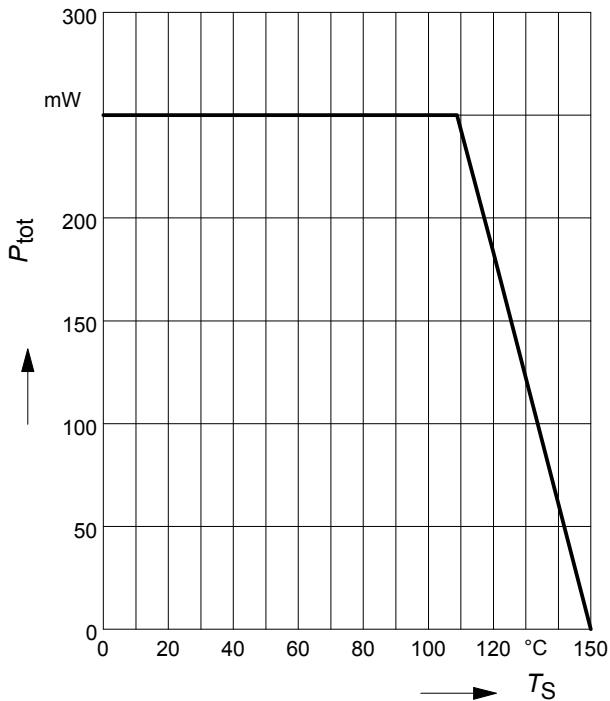
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
BCR183L3

**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
BCR183S



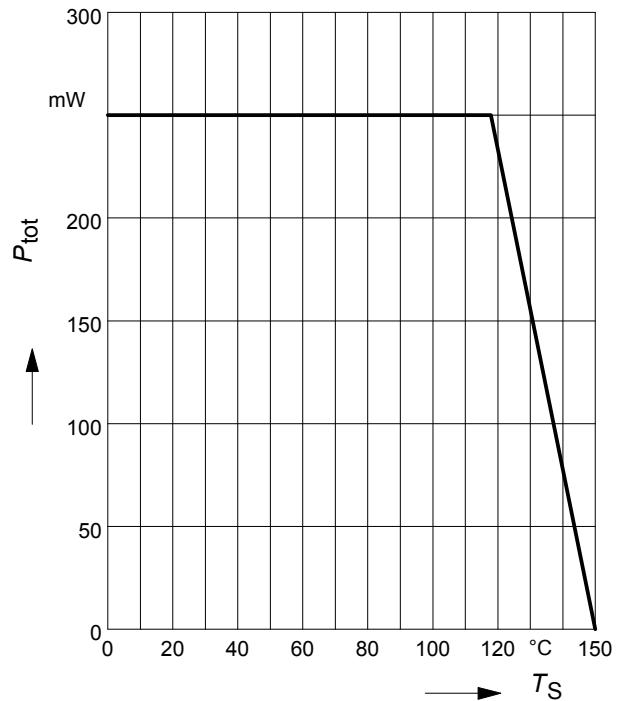
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**

BCR183T



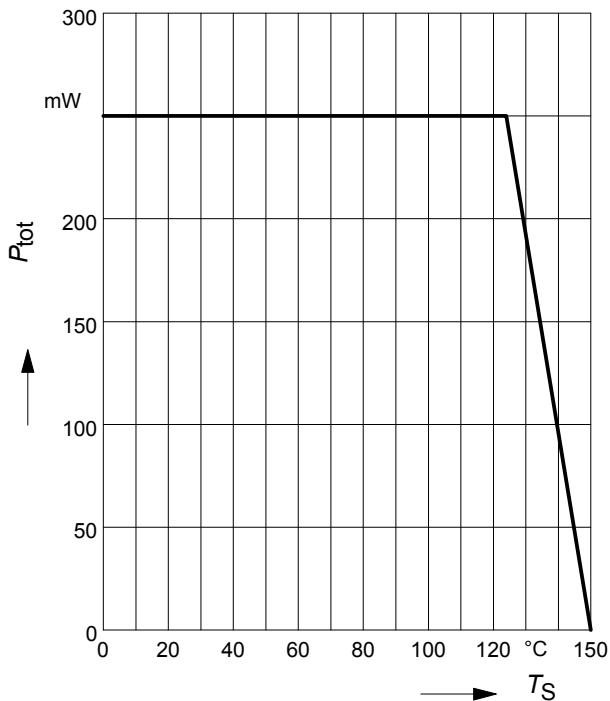
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**

BCR183U



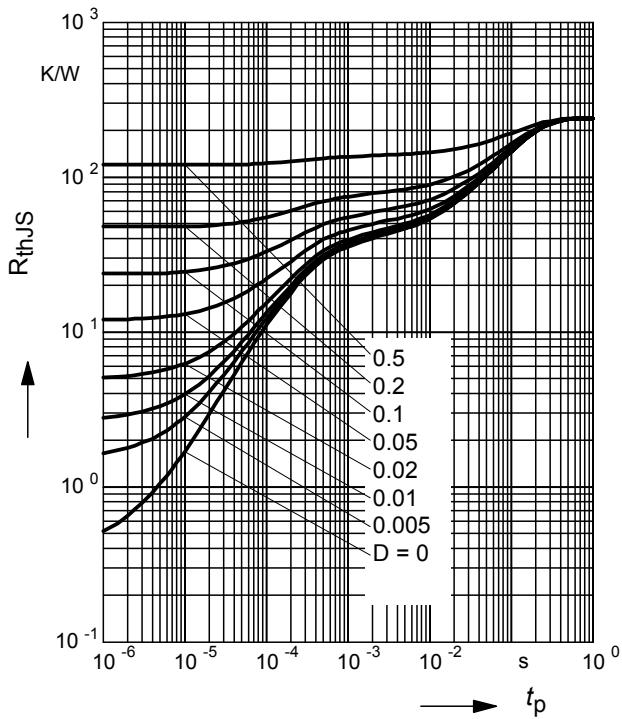
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**

BCR183W



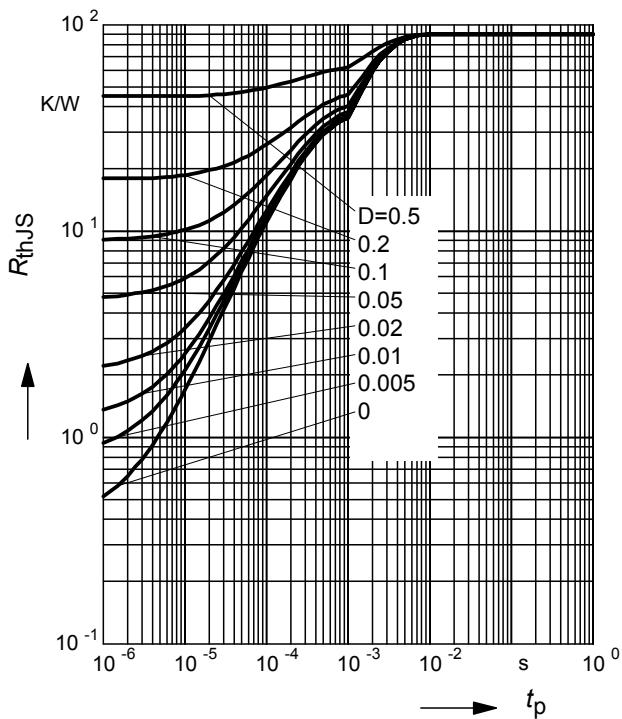
**Permissible Pulse Load**  $R_{\text{thJS}} = f(t_p)$

BCR183



**Permissible Puls Load**  $R_{\text{thJS}} = f(t_p)$

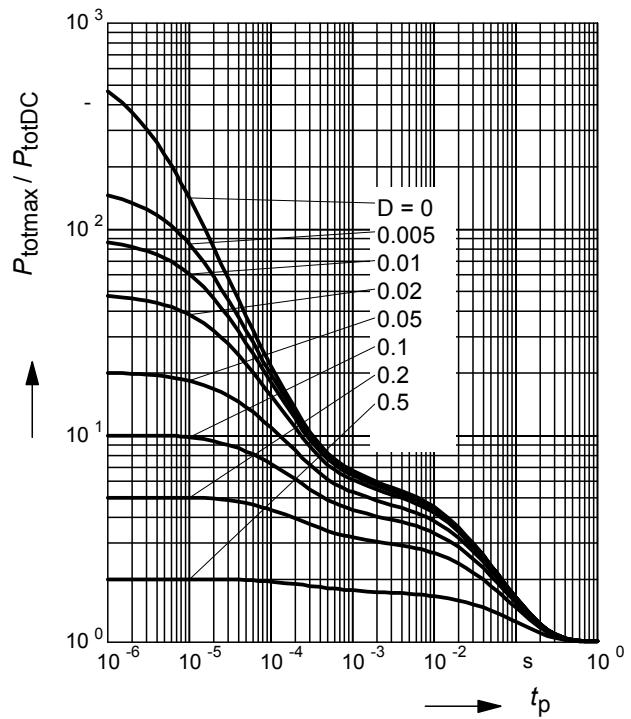
BCR183F



**Permissible Pulse Load**

$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$

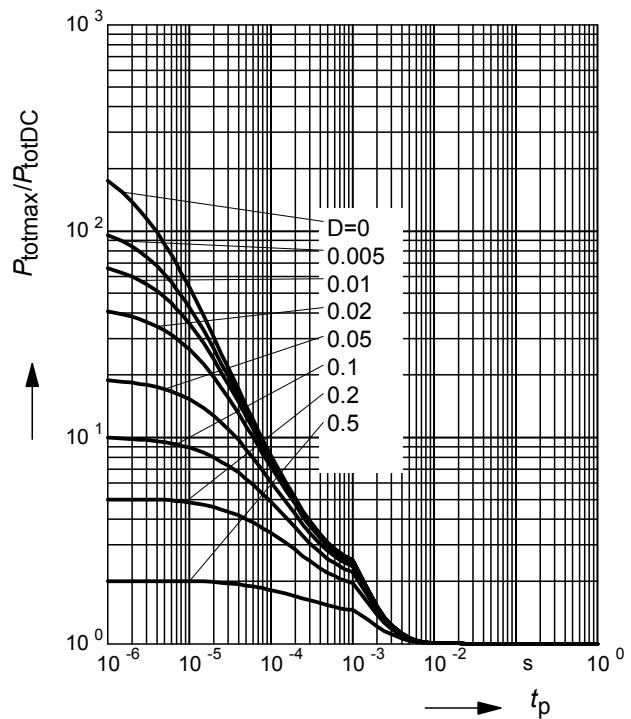
BCR183



**Permissible Pulse Load**

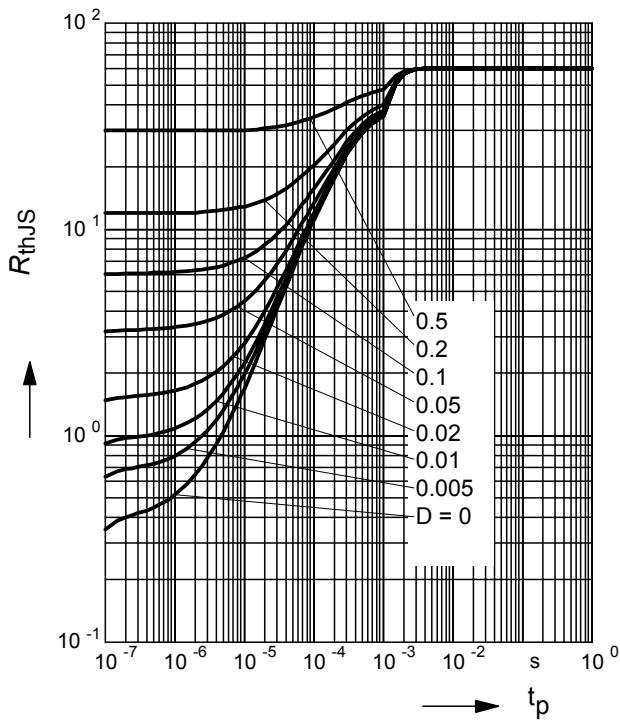
$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$

BCR183F

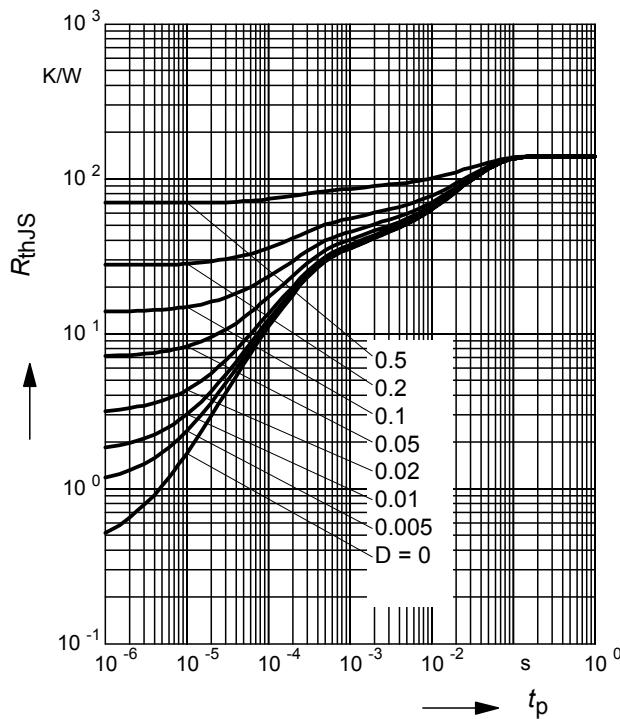


**Permissible Puls Load  $R_{\text{thJS}} = f(t_p)$** 

BCR183L3

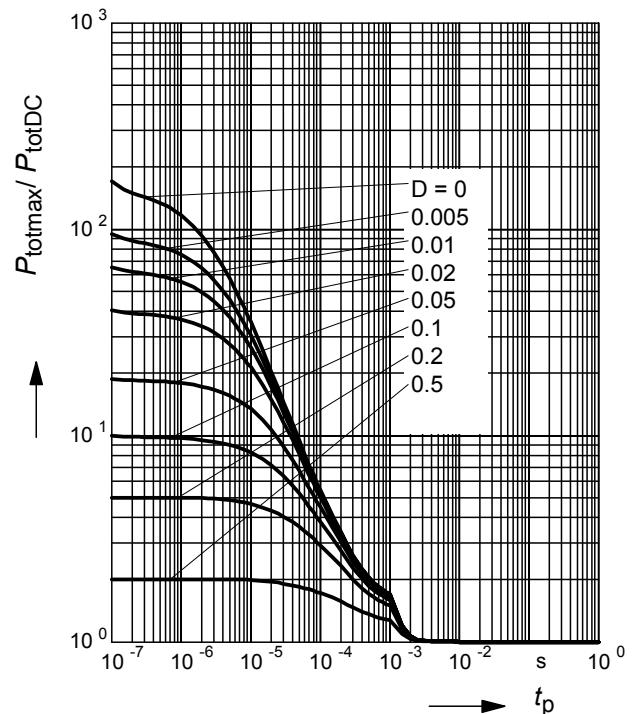

**Permissible Puls Load  $R_{\text{thJS}} = f(t_p)$** 

BCR183S


**Permissible Pulse Load**

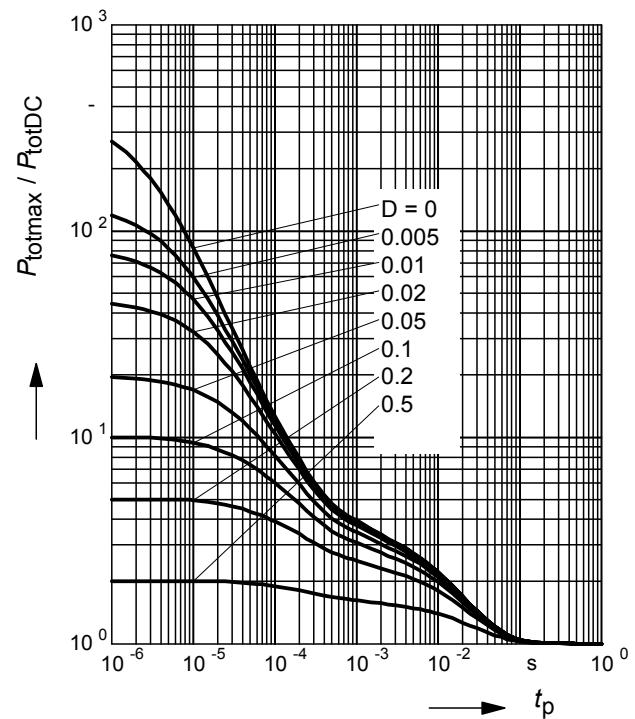
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

BCR183L3


**Permissible Pulse Load**

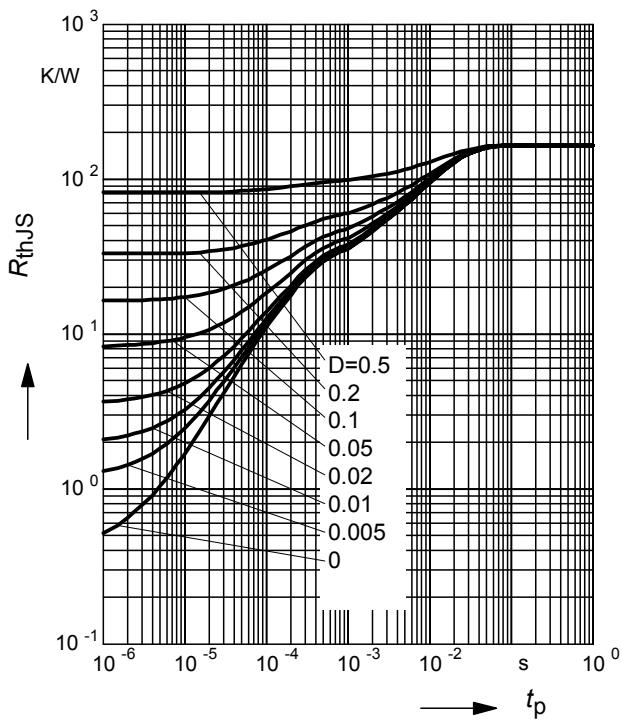
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

BCR183S

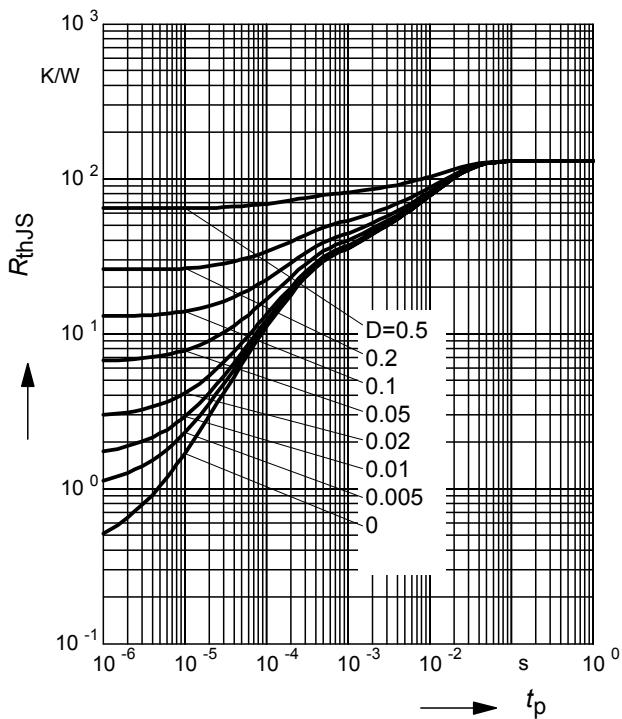


**Permissible Puls Load  $R_{\text{thJS}} = f(t_p)$** 

BCR183T

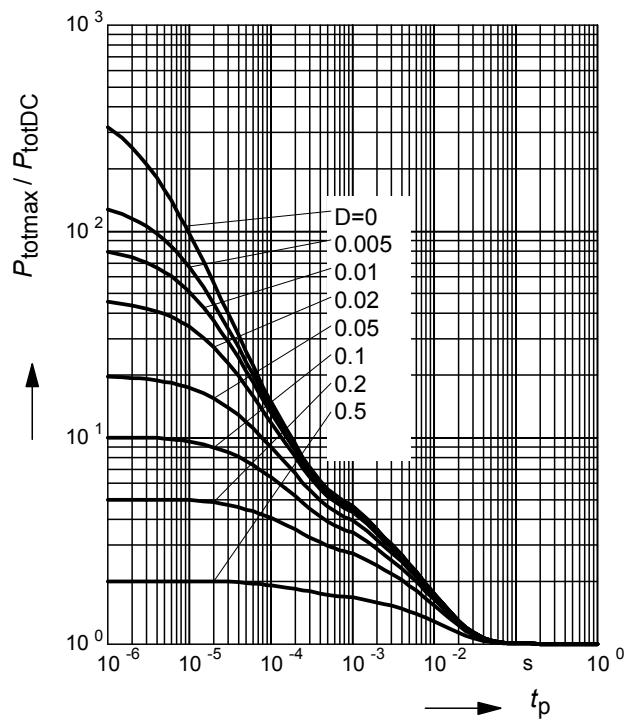

**Permissible Puls Load  $R_{\text{thJS}} = f(t_p)$** 

BCR183U


**Permissible Pulse Load**

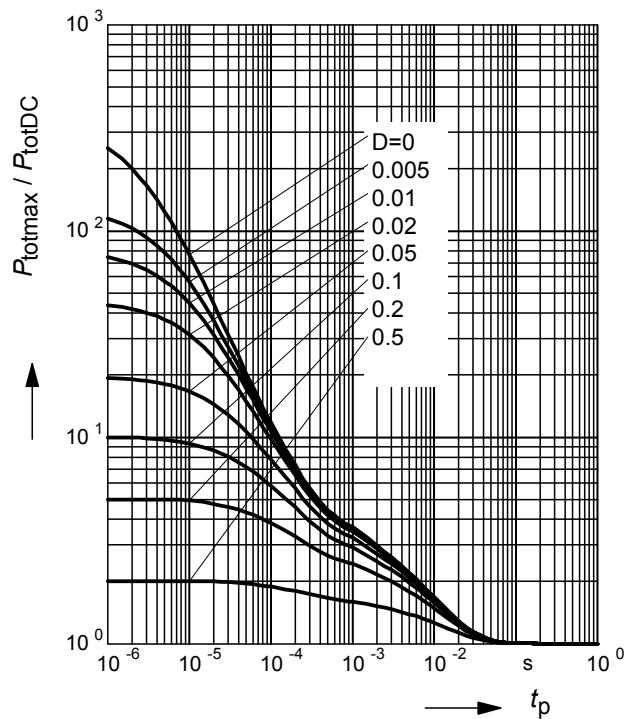
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

BCR183T


**Permissible Pulse Load**

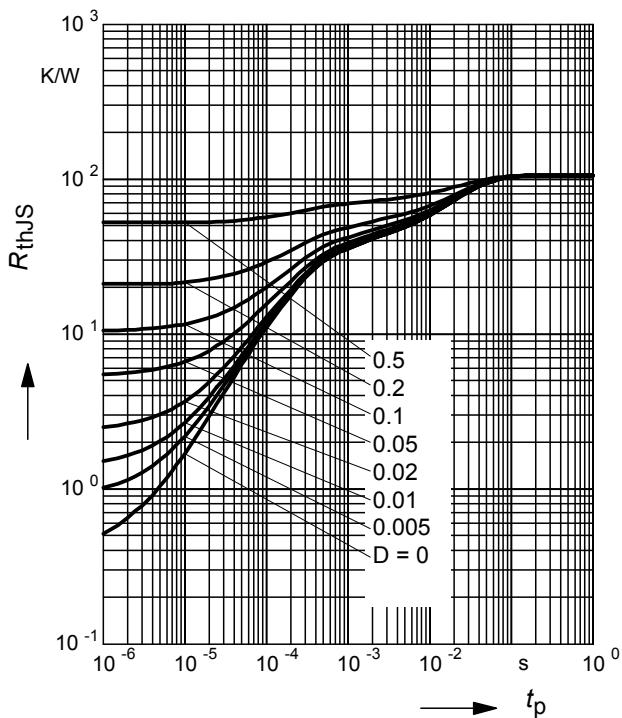
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

BCR185U



**Permissible Puls Load**  $R_{\text{thJS}} = f(t_p)$

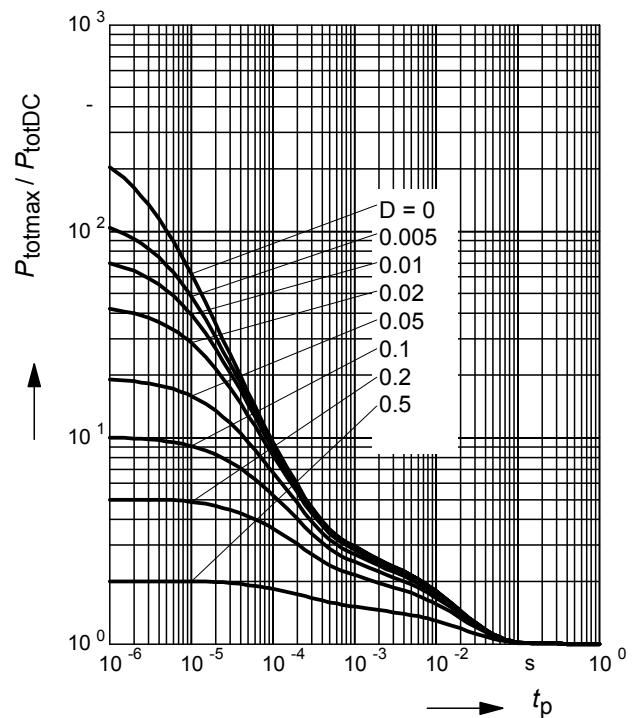
BCR183W



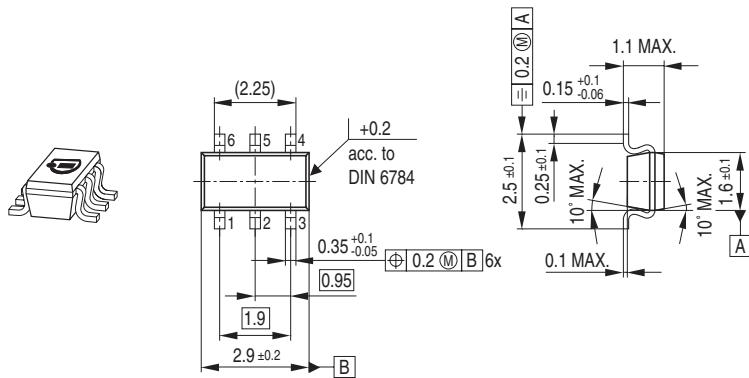
**Permissible Pulse Load**

$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$

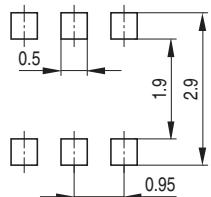
BCR183W



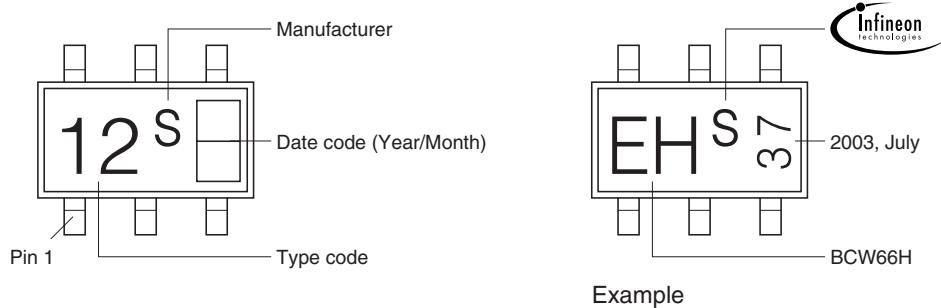
### Package Outline



### Foot Print



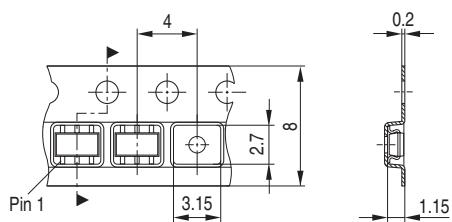
### Marking Layout



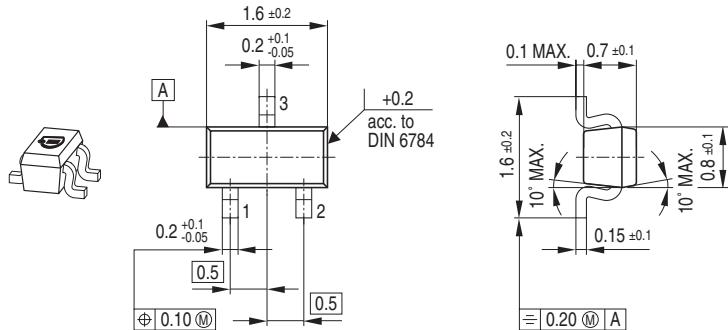
### Packing

Code E6327: Reel ø180 mm = 3.000 Pieces/Reel

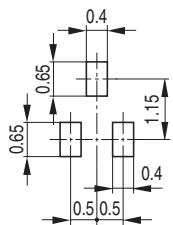
Code E6433: Reel ø330 mm = 10.000 Pieces/Reel



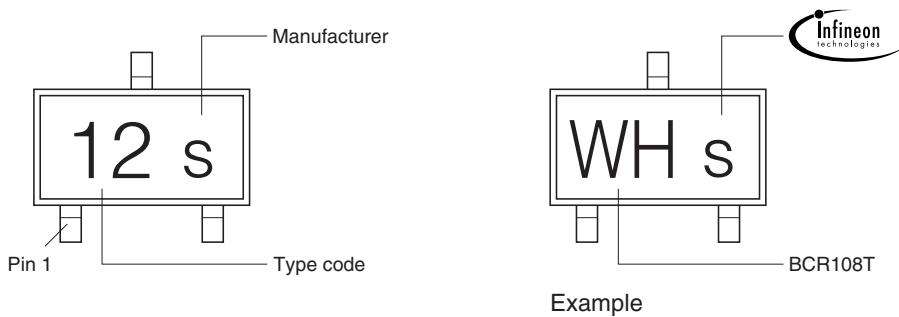
### Package Outline



### Foot Print



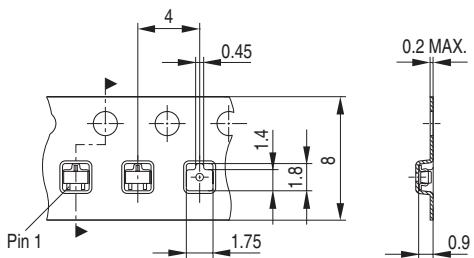
### Marking Layout



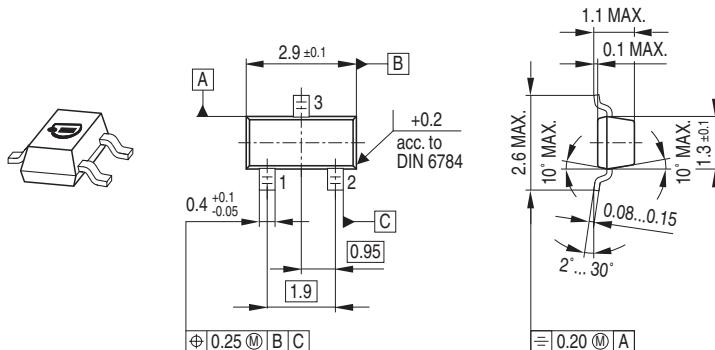
### Packing

Code E6327: Reel ø180 mm = 3.000 Pieces/Reel

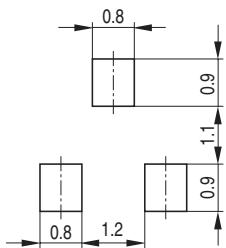
Code E6433: Reel ø330 mm = 10.000 Pieces/Reel



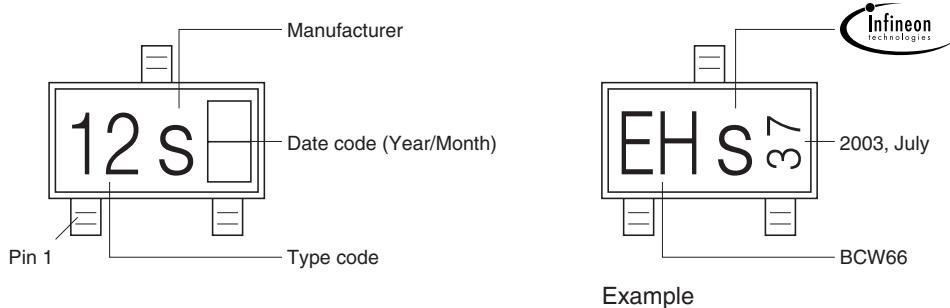
### Package Outline



### Foot Print



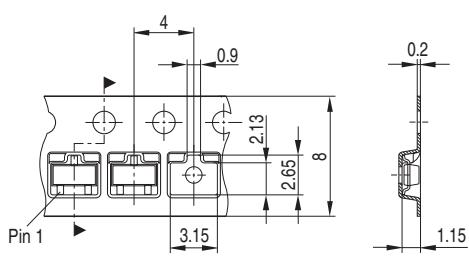
### Marking Layout



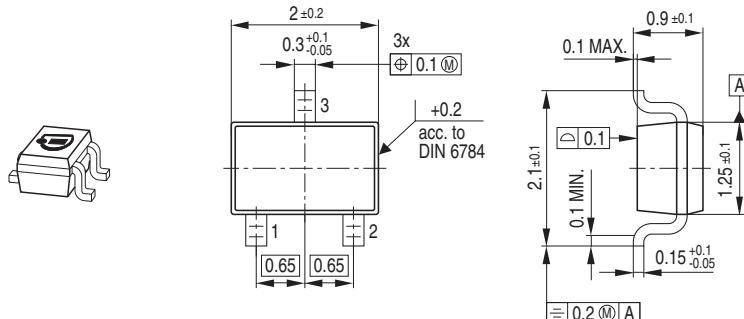
### Packing

Code E6327: Reel ø180 mm = 3.000 Pieces/Reel

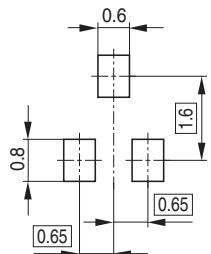
Code E6433: Reel ø330 mm = 10.000 Pieces/Reel



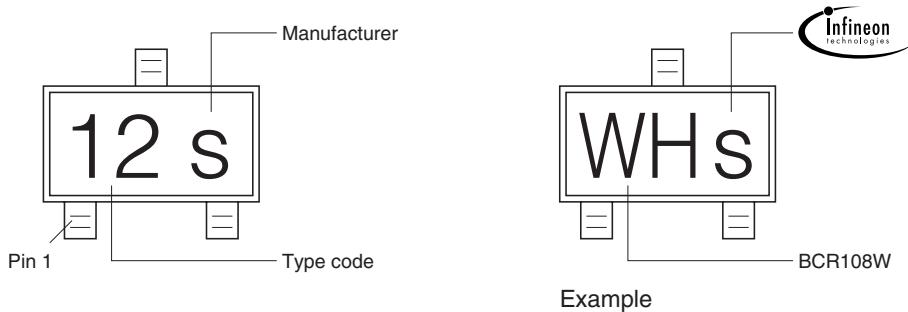
### Package Outline



### Foot Print

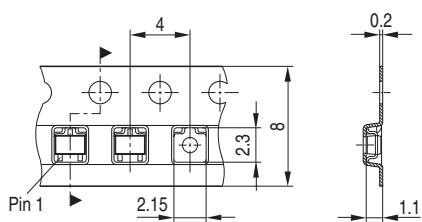


### Marking Layout

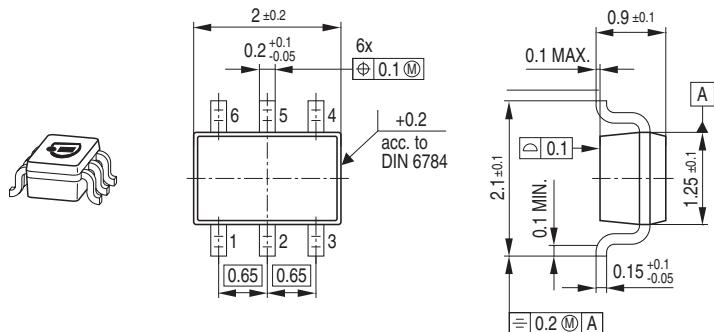


### Packing

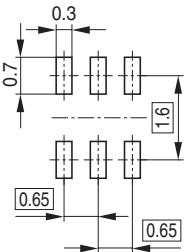
Code E6327: Reel ø180 mm = 3.000 Pieces/Reel  
 Code E6433: Reel ø330 mm = 10.000 Pieces/Reel



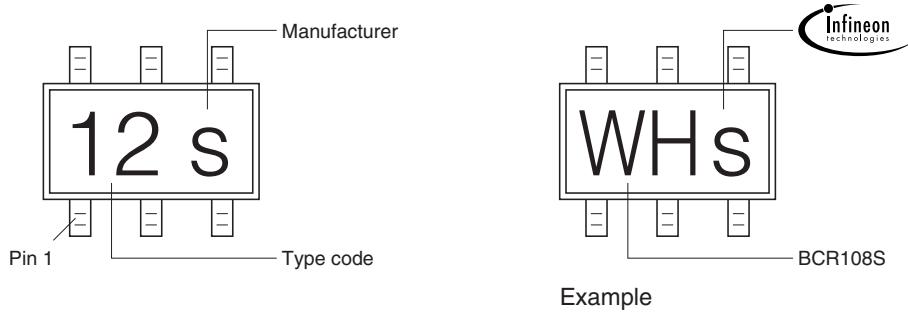
### Package Outline



### Foot Print

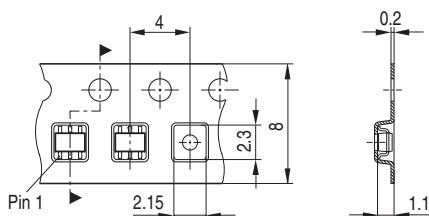


### Marking Layout

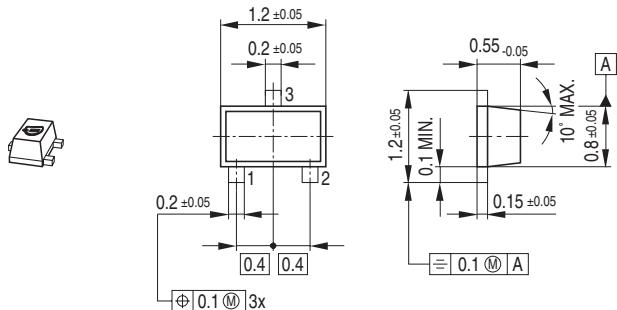


### Packing

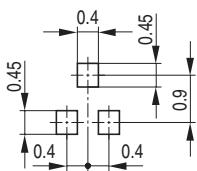
Code E6327: Reel ø180 mm = 3.000 Pieces/Reel  
 Code E6433: Reel ø330 mm = 10.000 Pieces/Reel



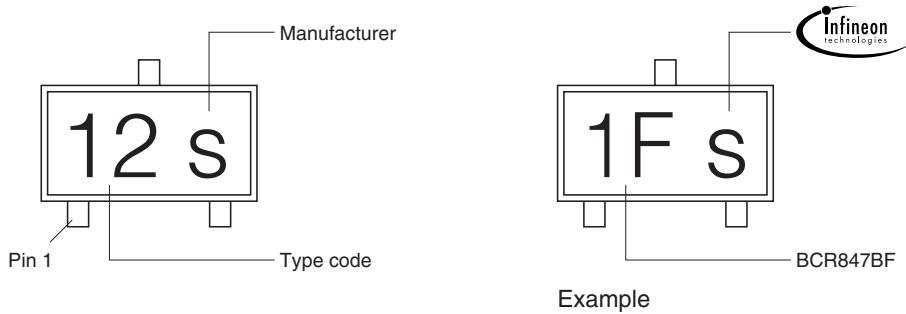
### Package Outline



### Foot Print

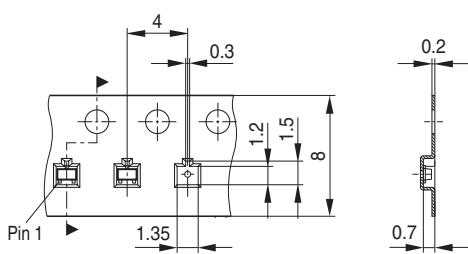


### Marking Layout

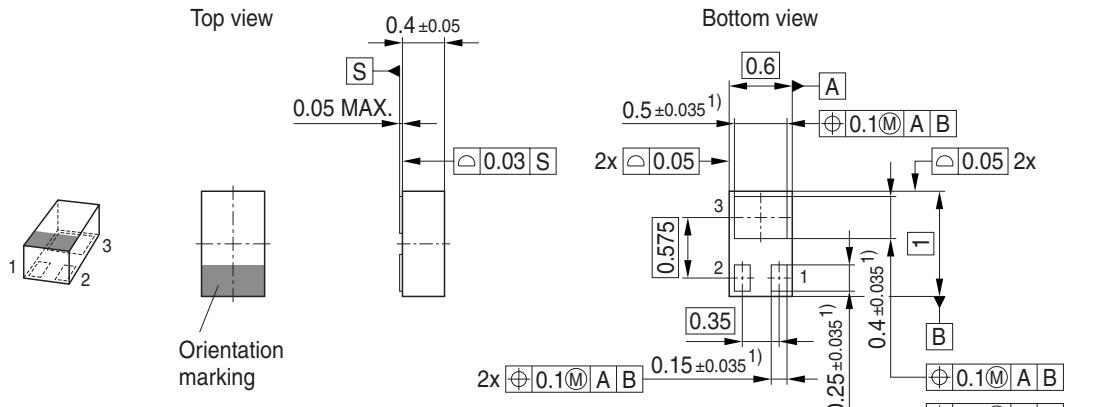


### Packing

Code E6327: Reel ø180 mm = 3.000 Pieces/Reel  
 Code E6433: Reel ø330 mm = 10.000 Pieces/Reel

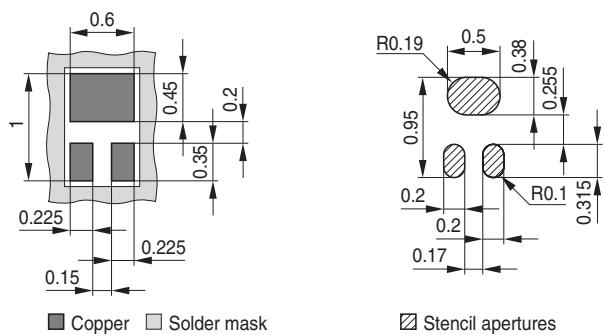


### Package Outline

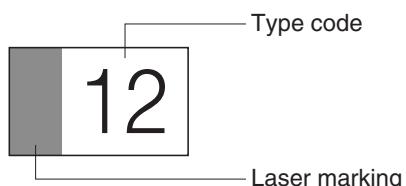


1) Dimension applies to plated terminals

### Foot Print

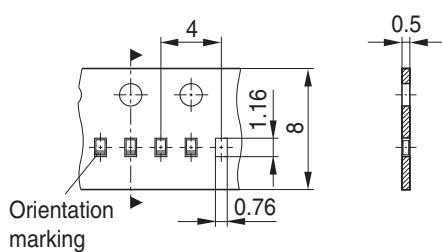


### Marking Layout



### Packing

Code E6327: Reel ø180 mm = 15.000 Pieces/Reel



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